

DAC014N120ZZ5

Silicon Carbide Enhancement Mode MOSFET

Features

- · High blocking voltage
- · High frequency operation
- Low on-resistance
- Fast intrinsic diode with low reverse recovery
- 100% Avalanche tested

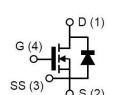
Benefits

- Higher system efficiency
- · High temperature application
- · Hard switching & higher reliability
- Parallel device convenience without thermal runaway
- Easy to drive

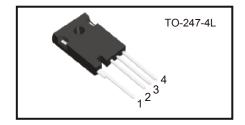
Applications

- Motor Drives
- Solar Inverters
- AC/DC converters
- DC/DC converters
- Uninterruptible power supplies

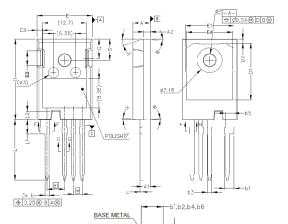
Preliminary



V_{DSS}	1200V
I _{D(@25°C)}	135A
$R_{DS(ON)}$	$14m\Omega$



Package Dimensions



SECTION "F-F", "G-G" AND "H-H"

	SECTION "F-F", "G-G" AND "H-H" SCALE: NONE						
4	SYMBOL	MILLIMETERS		OVA AD OL	MILLIMETERS		
	SYMBOL	MIN	MAX	SYMBOL	MIN	MAX	
	Α	4.83	5.21	Е	15.75	16.13	
	A1	2.29	2.54	E1	13.10	14.15	
	A2	1.91	2.16	E2	3.68	5.10	
4	b'	1.07	1.28	E3	1.00	1.90	
	b	1.07	1.33	E4	12.38	13.43	
	b1	2.39	2.94	е	2.54	BSC	
1	b2	2.39	2.84	e1	5.08	BSC	
	b3	1.07	1.60	N	4	l	
4	b4	1.07	1.50	L	17.31	17.82	
	b5	2.39	2.69	L1	3.97	4.37	
	b6	2.39	2.64	L2	2.35	2.65	
	c'	0.55	0.65	øΡ	3.51	3.65	
	С	0.55	0.68	Q	5.49	6.00	
┪	D	23.30	23.60	S	6.04	6.30	
	D1	16.25	17.65	T	17.5°	REF.	
	D2	0.95	1.25	W	3.5 ° REF.		

REF

Absolute Maximum Ratings

(Tc = 25°C unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage V _{cs} =0V I _D =100μA	V _{DS}	1200	٧
Gate - Source Voltage (dynamic) T _{surge} <100ns	V _{GS(max.)}	-8/+19	٧
Gate - Source Voltage (static)	V _{GS(op)}	-4/+15	٧
Drain Current-Continuous V _{GS} =15V,T _C =25°C V _{GS} =15V,T _C =100°C	I _D	135 95	Α
Pulse Drain Current	I _{D,pulse}	400	Α
Total Power Dissipation	P _D	600	W
Storage Temperature Range	T _{STG}	-55 to +175	°C
Operating Junction Temperature Range	TJ	-55 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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Electrical Characteristics @ Tc =25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit		
OFF Characteristics								
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V , I _D =0.1mA	1200	-	-	٧		
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} =0V , V _{DS} =1200V	-	1	50	μΑ		
Gate-Source Leakage Current	I _{GSS}	V _{GS} =15V · V _{DS} =0V	-	1	200	nA		
ON Characteristics								
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 27mA$	2.0	2.5	3.8	٧		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =15V , I _D =80A	-	14	18	mΩ		
Transconductance	g fs	V _{DS} = 20V · I _D =80A	-	68	-	S		
Internal Gate Resistance	$R_{G(int.)}$		-	1.4	-	Ω		
Dynamic Characteristics								
Input Capacitance	C _{iss}		-	6300	-	pF		
Output Capacitance	C _{oss}	V _{DS} =1000V	1	260	-			
Reverse Transfer Capacitance	C _{rss}	V _{GS} =0V Freq.=100kHz	-	16	-			
Coss Stored Energy	E _{oss}		-	150	-	μJ		
Turn-On Switching Energy	Eon	V _{DS} =800V , V _{GS} =-4V/+15V	-	1380	-	μJ		
Turn-Off Switching Energy	E _{off}	I_D =80A , $R_{G(ext)}$ =2.0 Ω L=100 μ H	-	210	-			
Switching Characteristics	l			ı				
Turn-On Delay Time	t _{d(on)}	V_{DS} =800V V_{GS} =-4/+15V I_{D} =80A $R_{G(ext)}$ =2.0 Ω	-	34	-	ns		
Rise Time	t _r		-	33	-			
Turn-Off Delay Time	t _{d(off)}		-	50	-			
Fall Time	t _f	L=100µH	ı	11	1			
Total Gate Charge	Qg	V _{DS} =800V	-	250	-			
Gate to Source Charge	\mathbf{Q}_{gs}	V _{GS} =-4/+15V	ı	76	1	nC		
Gate to Drain Charge	\mathbf{Q}_{gd}	I _D =80A	-	98	-			
Body Diode Characteristics	1			'				
Inverse Diode Forward Voltage	V _{SD}	V _{GS} =-4V , I _{SD} =40A	-	4.0	-	٧		
Continuous Diode Forward Current	Is	V _{GS} =-4V	-	-	100	Α		
Reverse Recovery Time	T _{rr}	V _{GS} =-4V	-	24	-	ns		
Reverse Recovery Charge	Qrr	I _{SD} =80A , V _R =800V,	1	630	1	nC		
Peak Reverse Recovery Current	I _{rrm}	dif/dt=4200A/μs	-	48	-	Α		
Thermal Resistance								
Thermal Resistance, Junction-to-Case	$R heta_Jc$		-	0.25	-	°C/W		

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Fig 1. Output Characteristics, T_J = -55°C

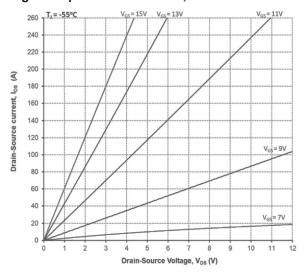


Fig 3. Output Characteristics, T_J = 175°C

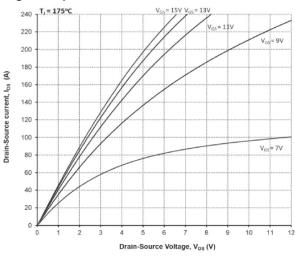


Fig 5. On-Resistance vs. Drain Current For Various Temperatures

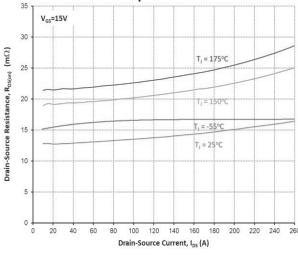


Fig 2. Output Characteristics, T_J = 25°C

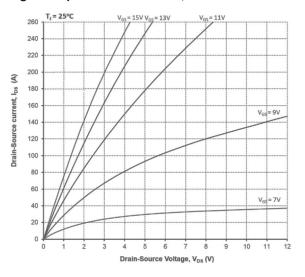


Fig 4. On-Resistance vs. Temperature

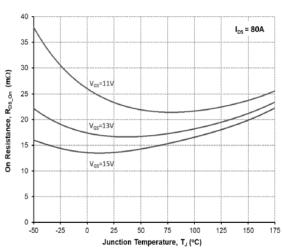


Fig 6. Transfer Characteristic For Various Junction Temperatures

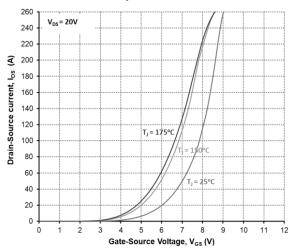




Fig 7. Threshold Voltage vs. Temperature

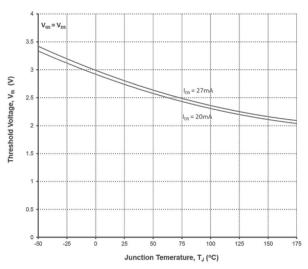


Fig 9. Body Diode Characteristics @ 25°C

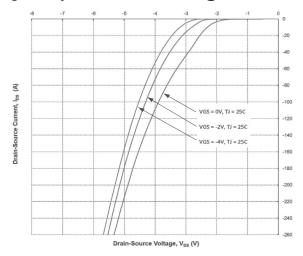


Fig 11. Gate Charge Characteristics

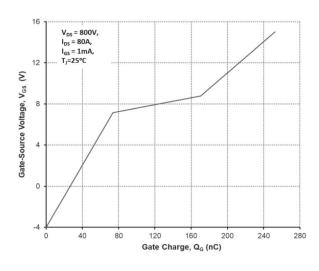


Fig 8.Body Diode Characteristics @ -55°C

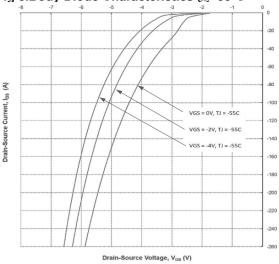


Fig 10. Body Diode Characteristics @ 175°C

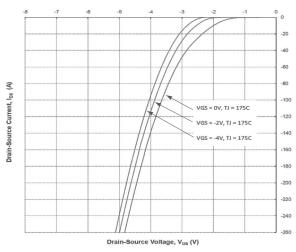
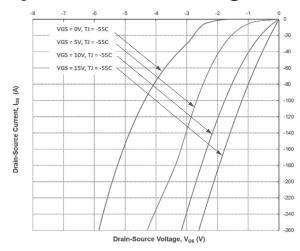


Fig 12. 3rd Quadrant Characteristics @ -55°C



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Fig 13. 3rd Quadrant Characteristics @ 25°C

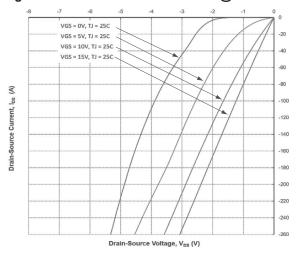


Fig 15. Output Capacitor Stored Energy

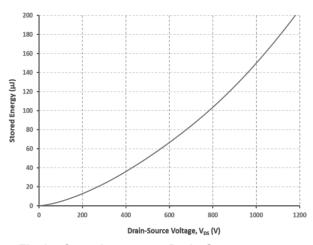


Fig 17. Capacitances vs. Drain-Source Voltage (0-1200V)

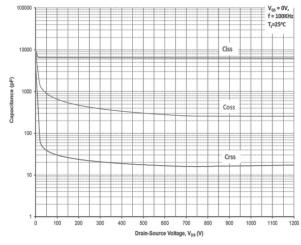


Fig 14. 3rd Quadrant Characteristics @ 175°C

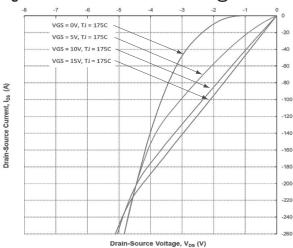


Fig 16. Capacitances vs. Drain-Source Voltage (0-200V)

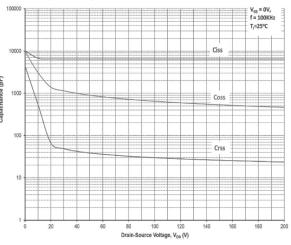


Fig 18. Continuous Drain Current Derating vs. Case Temperature

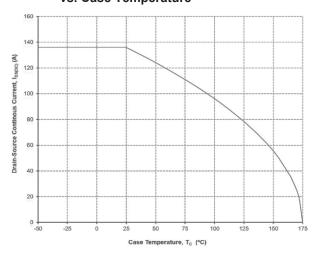




Fig 19. Maximum Power Dissipation Derating vs. Case Temperature

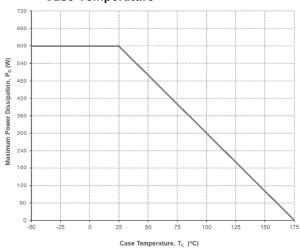


Fig 21. Safe Operating Area

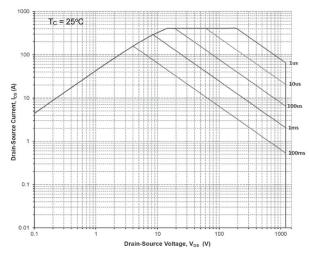


Fig 23. Switching Energy vs External Gate Resistor

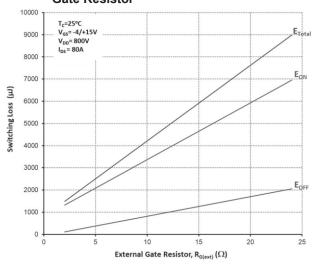


Fig 20. Transient Thermal Impedance (Junction to Case)

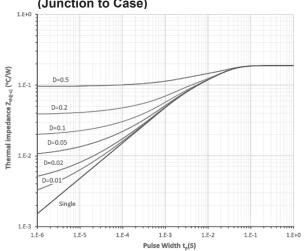


Fig 22. Switching Energy vs Drain Current

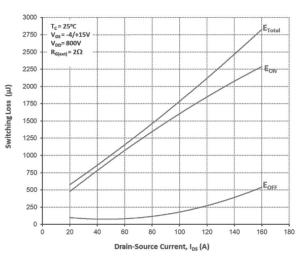
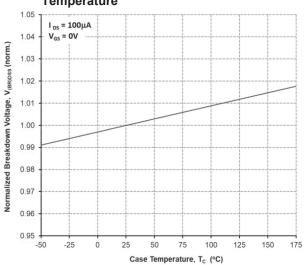


Fig 24. Normalized Breakdown Voltage vs Temperature







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